



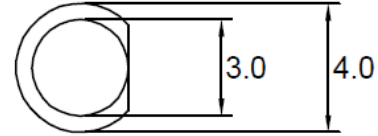
American Opto Plus LED Corp.

L314LWMC-30D

3mm Warm White LED Lamp

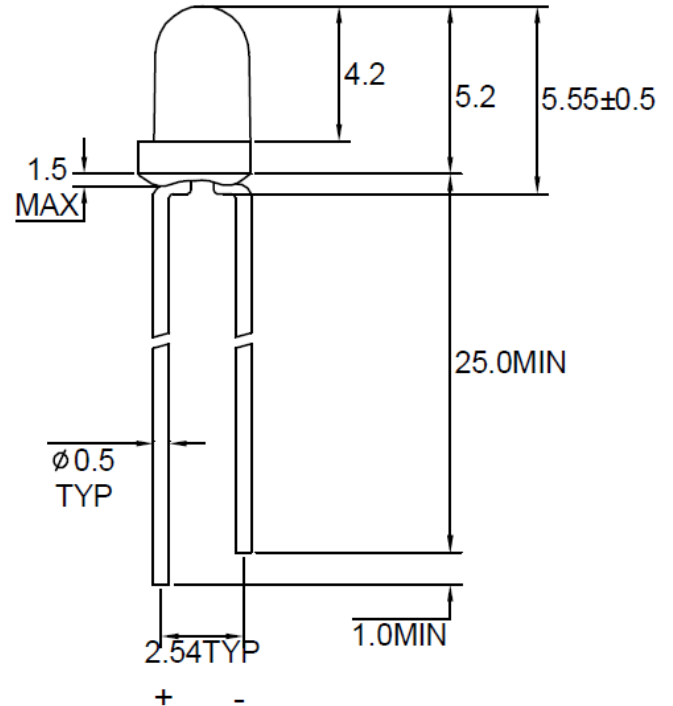
DESCRIPTION

- Round Type
- 3mm Diameter
- Lens Color: Water Clear
- With Flange
- Solder leads without standoffs



FEATURES

- Emitted Color: Warm White
- High Luminous Intensity
- Technology: InGaN/GaN
- Viewing Angle: 30°



NOTES:

1. All dimensions are in millimeters tolerance is ± 0.25 mm unless otherwise noted;

Part Number	Material	Lens Color	
		Emitted	Lens
L314LWMC-30D	InGaN/GaN	Warm White	Water Clear



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ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30	mA
Peak Forward Current Duty 1/10 @ 10KHz	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Power Dissipation	P _d	120	mW
Electrostatic Discharge *	ESD	150	V
Operating temperature range	T _{opr}	-20~+80	°C
Storage temperature range	T _{stg}	-30~+100	°C

* Static electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Current	I _R	V _R =5V	--	--	50	µA
Forward Voltage	V _F	I _F =20mA	--	3.5	4.0	V
Luminous Intensity	I _v		2200	5000	--	mcd
Chromaticity Coordinate	X		--	0.28	--	--
Chromaticity Coordinate	Y		--	0.28	--	--

- Note: 1. The forward voltage data did not include ±0.1V testing tolerance.
2. The luminous intensity data did not include ±15% testing tolerance.



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CHROMATICITY COORDINATES SPECIFICATIONS FOR BIN GRADING

BIN	X	Y	BIN	X	Y
A5	0.25	0.250	B5	0.30	0.325
	0.25	0.210		0.30	0.285
	0.26	0.225		0.31	0.300
	0.26	0.265		0.31	0.340
B1	0.26	0.265			
	0.26	0.225			
	0.27	0.240			
	0.27	0.280			
B2	0.27	0.280			
	0.27	0.240			
	0.28	0.255			
	0.28	0.295			
B3	0.28	0.295			
	0.28	0.255			
	0.29	0.270			
	0.29	0.310			
B4	0.29	0.310			
	0.29	0.270			
	0.30	0.285			
	0.30	0.325			

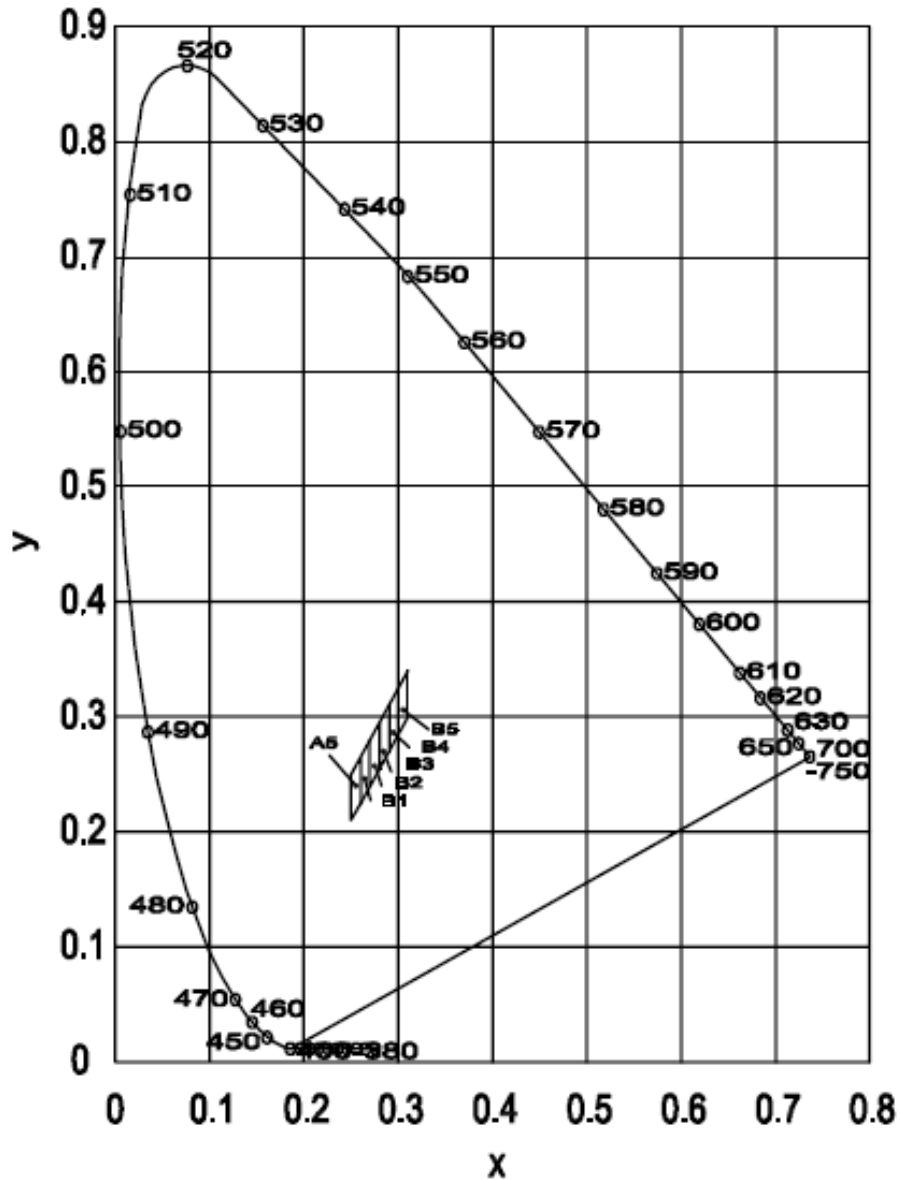


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CIE CHROMATICITY DIAGRAM





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TYPICAL ELECTRO-OPTICAL CHARACTERISTICS CURVE

Fig.1 Forward current vs. Forward Voltage

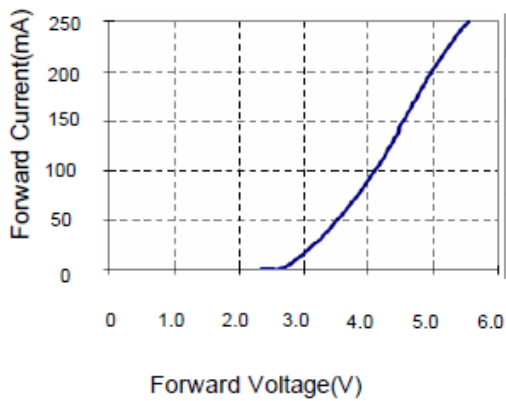


Fig.2 Relative Intensity vs. Forward Current

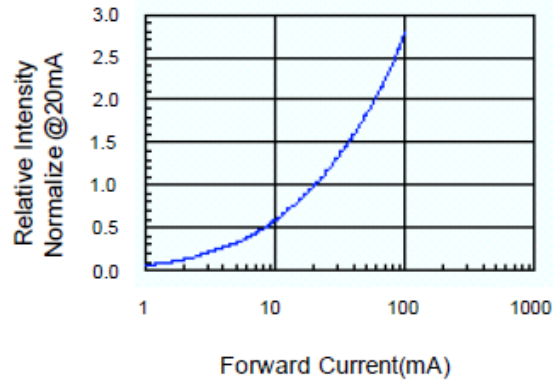


Fig.3 Forward Voltage vs. Temperature

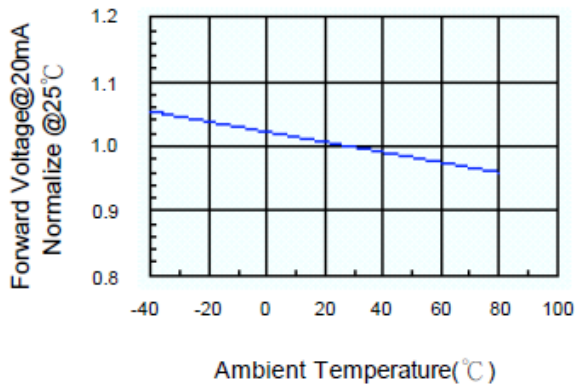


Fig.4 Relative Intensity vs. Temperature

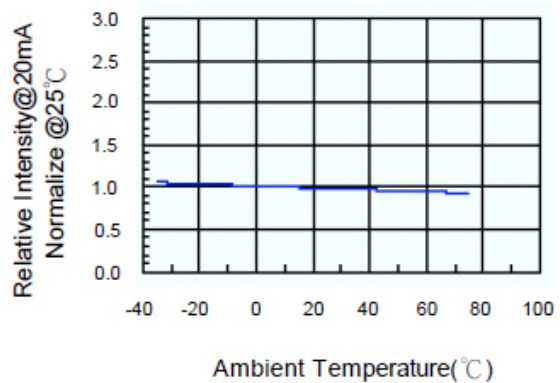
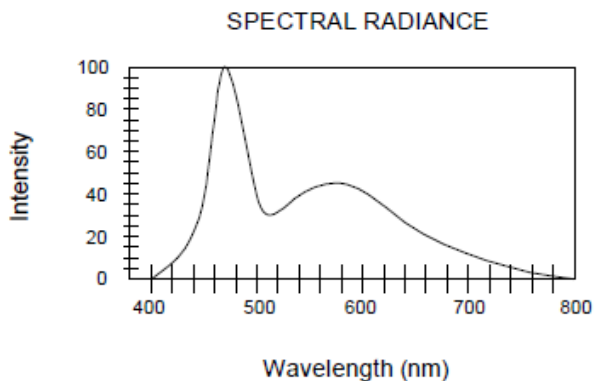


Fig.5 Luminous Spectrum (Ta=25°C)





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SOLDERING CONDITIONS (Pb-Free)

1. Iron:

Soldering Iron: 30W Max

Temperature 350°C Max

Soldering Time: 3 seconds max (one time only)

Distance: 2mm Min (from solder joint to body)

2. Wave Soldering Profile

Dip Soldering

Preheat: 120°C Max

Preheat time: 60 seconds Max

Ramp-up

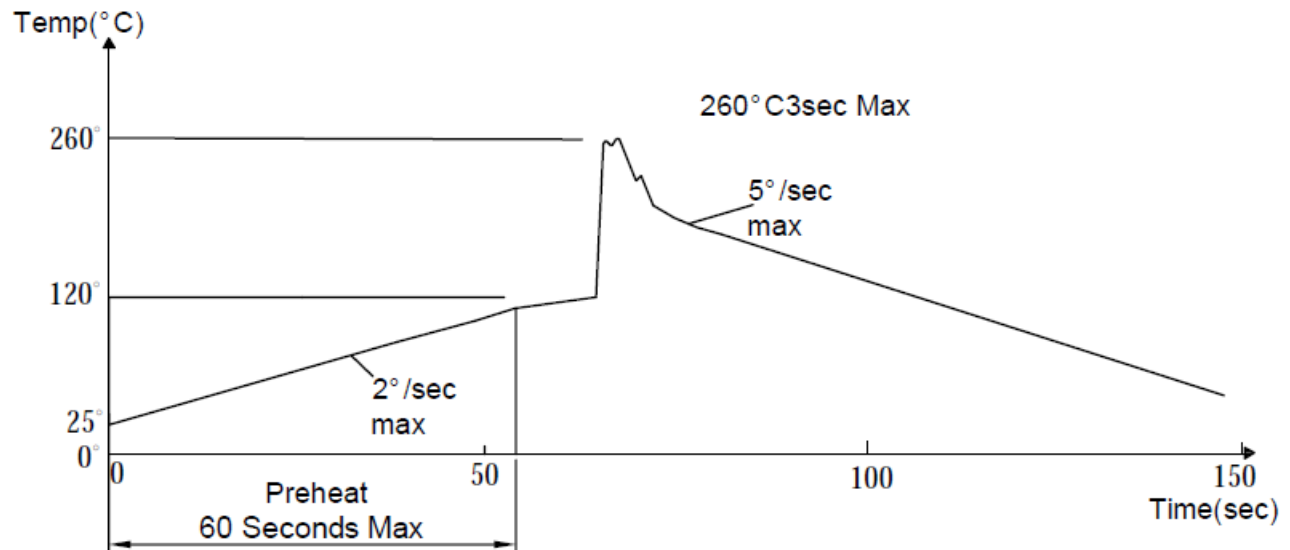
2°C/sec (max)

Ramp-Down: -5°C/sec (max)

Solder Bath: 260°C Max

Dipping Time: 3 seconds Max

Distance: 2mm Min (from solder joint to body)



Note: 1. Wave solder should not be made more than once.

2. You can just only select one of the soldering conditions above.



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RELIABILITY TEST:

Test Item	Test Condition	Description	Reference Standard
Operating Life Test	1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed.	MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1
High Temperature Storage Test	1.Ta=105 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of high temperature for hours.	MIL-STD-883:1008 JIS C 7021: B-10
Low Temperature Storage Test	1.Ta=-40 °C±5°C 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.	JIS C 7021: B-12
High Temperature High Humidity Test	1.Ta=65 °C±5°C 2.RH=90%~95% 3.t=240hrs ±2hrs	The purpose of this test is the resistance of the device under tropical for hours.	MIL-STD-202:103B JIS C 7021: B-11
Thermal Shock Test	1.Ta=105 °C±5°C & -40°C±5°C (10min) (10min) 2.total 10 cycles	The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011
Solder Resistance Test	1.T.Sol=260 °C±5°C 2.Dwell time= 10 ±1sec.	This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire.	MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1
Solderability Test	1.T.Sol=230 °C±5°C 2.Dwell time=5 ±1sec	This test intended to see soldering well performed or not.	MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2